Materials List for: Fabrication and Characterization of a Conformal Skin-like Electronic System for Quantitative, Cutaneous Wound Management

Woosik Lee¹, Ohjin Kwon¹, Dong Sup Lee¹, Woon-Hong Yeo^{1,2,3}

¹Department of Mechanical and Nuclear Engineering, Virginia Commonwealth University

²Center for Rehabilitation Science and Engineering, Virginia Commonwealth University

³Massey Cancer Center, Virginia Commonwealth University

Correspondence to: Woon-Hong Yeo at whyeo@vcu.edu

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Materials

Name	Company	Catalog Number	Comments
3" Silicon wafer	University Wafer, USA		Use as carrier to fabricate the device
Acetone	Fisher Scientific, USA	A18-1	Use to clean a wafer and to remove photoresist
Isopropanol (IPA)	Fisher Scientific, USA	A459-1	Use to clean a wafer
AZ4620 photoresist	AZ Electrionic Materials, USA		Use to make patterns on metals and polymers
AZ400K developer	AZ Electrionic Materials, USA		Use to develop AZ4620 photoresist
Chromium etchant	Transene, USA	1020AC	Use to etch Cr layer of device
Copper etchant	Transene, USA	ASP-100	Use to etch Cu layer of device
Sylgard 184 Silicone Elastomer Kit (PDMS)	Dow Corning, USA	39100000	Use as a substrate for 'dry' retrieval
PI2545 polyimide	HD MicroSystem, USA		Use to encapsulate metal layer
Solaris	Smooth-On, USA		Use as substrate and to encapsulate device
Petridish	Carolina, USA	741255	Use as mold to make substrate
Water-Soluble Wave Solder Tape 5414	3M, USA	AM00000217	Use to retrive device from PDMS layer
High Activity Liquid Stainless Steel Flux	Worthington, USA	331929	Use to remove oxidation layer on Cu
Flexible, micro-film cable	Elform, USA		Use to make the electrical connection between the electronic device and the data acquisition system
pH Neutral Cleaner	Australian Gold, USA		Use as disinfectant solution to clean device in clinical testing
Solder	Kester, USA		Use as material to solder hard wires
Ultraviolet lamp	Cole-Parmer, USA	97600-00	Use to activate PDMS layer as hydrophilic surface
Multiplexer	FixYourBoard, USA	U802	Use to acquire measurements from six sensing components
DC/AC current source	Keithley, USA	6221	Use to supply current
SMD Digital Hot Air Rework Station	Aoyue, China	968A+	Use to solder hard wires, to electrically connect between the device and external instruments
Infrared camera	FLIR, USA	435-0001-01-00	Use to take infrared images in experiment



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Digital multimeter	Fluke, USA	117	Use to check electrical connection
Lock-in amplifier	Stanford Research System, USA		Use to perform four-point-probe- measurement
Electron beam evaporator	9 scale Vacuum Products, USA		Use to deposit thin films (Cu and SiO_2)